

Quik-Pak™

IC Prototypes - Any Package, Any Time

Open Cavity Plastic Packages and Assembly Services in 24 Hours or Less

QUIK-PAK ADVANTAGE

Quik-Pak's Products and Services Deliver a Competitive Advantage:

Fastest Time to Market for Your New Products

- Delivery of Packages or Assembled Parts in as Little as 8 Hours
- Prototypes Simulate Final Product Performance

Reduced Prototype Budget

- No Tooling Costs or Minimum Orders

Flexibility

- Virtually Unlimited Package Configurations
- Custom Prototype Assembly

Excellent Quality

- Tightly Controlled Manufacturing Processes

Outstanding Customer Service

- Excellent On-Time Delivery Record
- Personal Attention From Industry Experts

Quik-Pak

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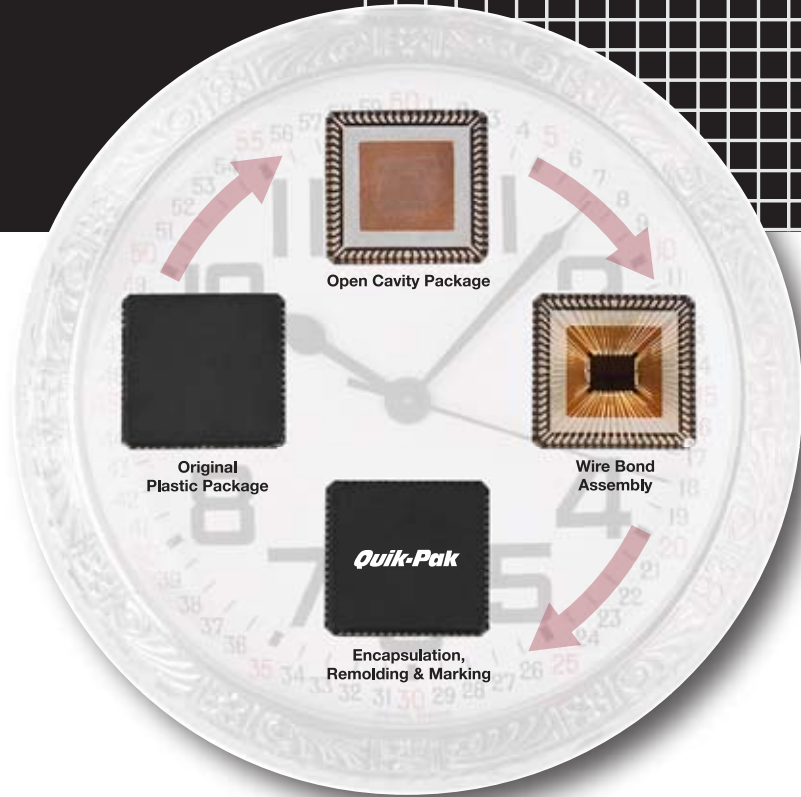
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www.icproto.com

A Division of

DELPHI Industries



Quik-Pak Products and Service Menu:

- **Open Cavity Plastic Packages**
Reconfigure any plastic package to accept new die, utilizing proprietary process.
- **IC Prototype Assembly (plastic or ceramic)**
Die attach & gold ball wire bonding.
- **Encapsulation Options**
From open cavity to fully encapsulated and remolded to JEDEC standards.
- **Package Marking/Branding**
Print your logo, part number and/or date code.
- **Wafer Sawing/Back-Grinding**
Wafer diameter up to 300mm.
- **Custom Assembly**
MEMS, chip-on-board, stacked die, etc.